NOT RECOMMENDED FOR NEW DESIGN
CONTACT US

Lead-free Green

DMC4040SSD

40V COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV_{DSS}	$R_{DS(ON)}$ Max	I_D Max (A) T_A = +25°C (Notes 6 & 8)
Q1	40V	25mΩ @ V_{GS} = 10V	7.5
		40mΩ @ V_{GS} = 4.5V	6.2
Q2	-40V	25mΩ @ V_{GS} = -10V	-7.3
		45mΩ @ V_{GS} = -4.5V	-5.7

Features and Benefits

- Matched N & P $R_{DS(ON)}$ – Minimizes Power Losses
- Fast Switching – Minimizes Switching Losses
- Dual Device – Reduces PCB Area
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **An Automotive-Compliant Part is Available Under Separate Datasheet (DMC4040SSDQ)**

Description

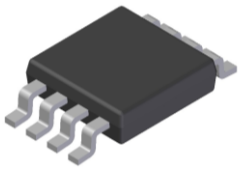
This MOSFET is designed to ensure that $R_{DS(ON)}$ of N and P channel FET are matched to minimize losses in both arms of the bridge. The DIODES™ DMC4040SSD is optimized for use in a 3-phase brushless DC motor circuit (BLDC), and CCFL backlighting.

Mechanical Data

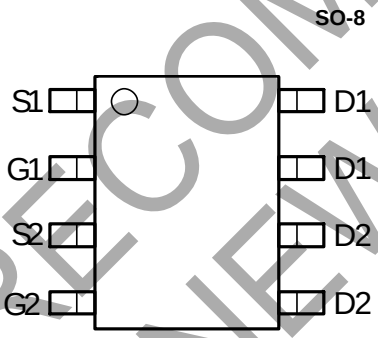
- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.074 grams (Approximate)

Applications

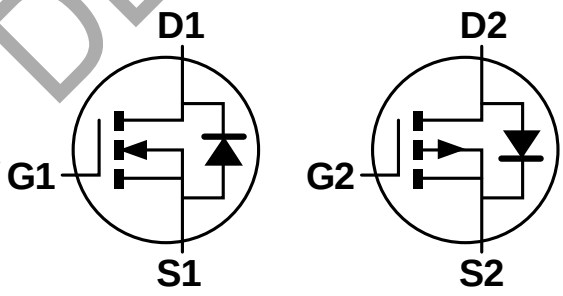
- 3-Phase BLDC motors
- CCFL backlighting



Top View



Top View



Q1 N-Channel Q2 P-Channel

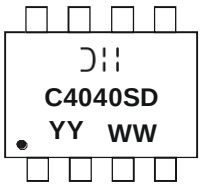
Equivalent Circuit

Ordering Information (Note 4)

Part Number	Package	Marking Code	Reel Size (Inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
DMC4040SSD-13	SO-8	C4040SD	13	12	2,500	Reel

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



= Manufacturer's Marking
C4040SD = Product Type Marking Code
YYWW = Date Code Marking
YY or $\overline{YY}$ = Year (ex: 23 = 2023)
WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

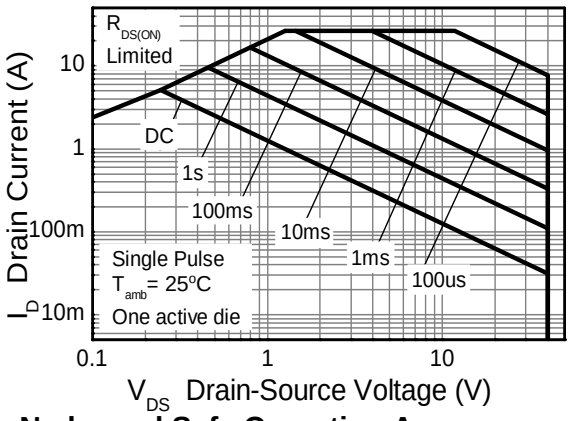
Characteristic			Symbol	N-Channel - Q1	P-Channel - Q2	Unit
Drain-Source Voltage			V_{DSS}	40	-40	V
Gate-Source Voltage			V_{GSS}	±20	±20	
Continuous Drain Current	V_{GS} = 10V	(Notes 6 & 8)	I_D	7.5	-7.5	A
		T_A = +70°C (Notes 6 & 8)		5.8	-5.8	
		(Notes 5 & 8)		5.7	-5.7	
		(Notes 5 & 9)		6.8	-6.8	
Pulsed Drain Current	V_{GS} = 10V	(Notes 7 & 8)	I_{DM}	29.0	-29.0	
Continuous Source Current (Body Diode)		(Notes 6 & 8)	I_S	3.0	-3.0	
Pulsed Source Current (Body Diode)		(Notes 7 & 8)	I_{SM}	29.0	-29.0	

Thermal Characteristics

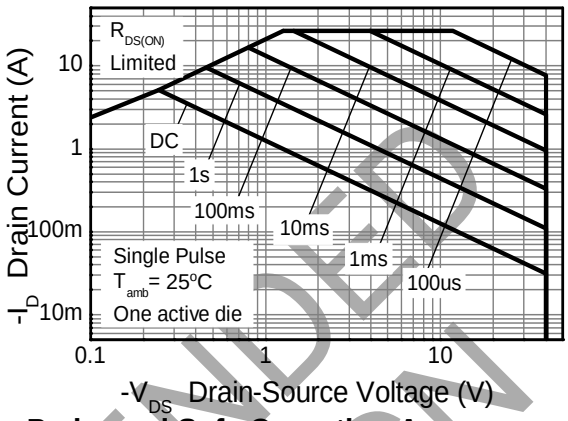
Characteristic		Symbol	N-Channel - Q1	P-Channel - Q2	Unit
Power Dissipation Linear Derating Factor	(Notes 5 & 8)	P_D	1.25 10		W mW/°C
	(Notes 5 & 9)		1.8 14.3		
	(Notes 6 & 8)		2.14 17.2		
Thermal Resistance, Junction to Ambient	(Notes 5 & 8)	$R_{\theta JA}$	100		°C/W
	(Notes 5 & 9)		70		
	(Notes 6 & 8)		58		
Thermal Resistance, Junction to Lead	(Notes 5 & 10)	$R_{\theta JL}$	51		
Operating and Storage Temperature Range		T_J, T_{STG}	-55 to +150		°C

Notes:
5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
6. Same as note (5), except the device is measured at t ≤ 10 sec.
7. Same as note (5), except the device is pulsed with D = 0.02 and pulse width 300µs.
8. For a dual device with one active die.
9. For a device with two active die running at equal power.
10. Thermal resistance from junction to solder-point (at the end of the drain lead).

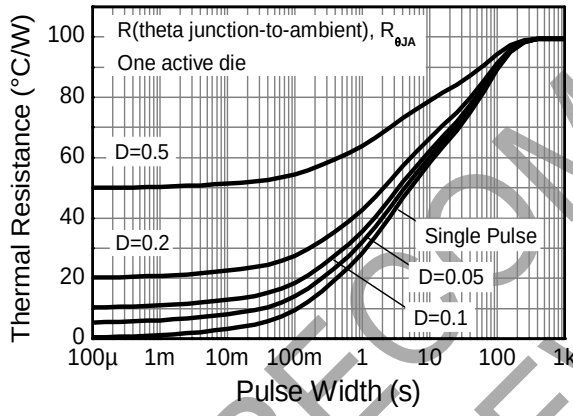
Thermal Characteristics (Continued)



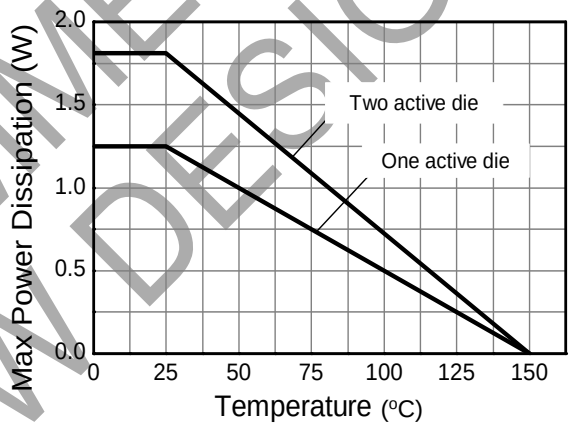
N-channel Safe Operating Area



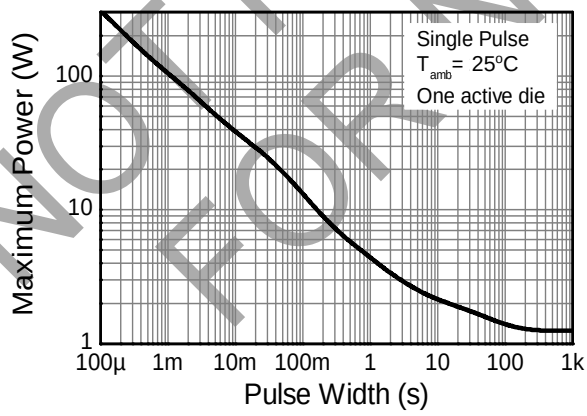
P-channel Safe Operating Area



Transient Thermal Impedance



Derating Curve



Pulse Power Dissipation

Electrical Characteristics (Q1 N-Channel) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	40	—	—	V	I_D = 250µA, V_{GS} = 0V
Zero Gate Voltage Drain Current	I_{DSS}	—	—	1.0	µA	V_{DS} = 40V, V_{GS} = 0V
Gate-Source Leakage	I_{GSS}	—	—	±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	0.8	1.3	1.8	V	I_D = 250µA, V_{DS} = V_{GS}
Static Drain-Source On-Resistance (Note 11)	$R_{DS(ON)}$	—	0.013	0.025	Ω	V_{GS} = 10V, I_D = 3A
			0.028	0.040		V_{GS} = 4.5V, I_D = 3A
Forward Transconductance (Notes 11 & 12)	G_{fs}	—	12.6	—	S	V_{DS} = 5V, I_D = 3A
Diode Forward Voltage (Note 11)	V_{SD}	—	0.7	1.0	V	I_S = 1A, V_{GS} = 0V
DYNAMIC CHARACTERISTICS (Note 12)						
Input Capacitance	C_{iss}	—	1,790	—	pF	V_{DS} = 20V, V_{GS} = 0V f = 1MHz
Output Capacitance	C_{oss}	—	160	—		
Reverse Transfer Capacitance	C_{rss}	—	120	—		
Gate Resistance	R_g	—	1.03	—	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz
Total Gate Charge (Note 13)	Q_g	—	16.0	—	nC	V_{GS} = 4.5V; V_{DS} = 20V, I_D = 3A
Total Gate Charge (Note 13)	Q_g	—	37.6	—		V_{GS} = 10V; V_{DS} = 20V, I_D = 3A
Gate-Source Charge (Note 13)	Q_{gs}	—	7.8	—		
Gate-Drain Charge (Note 13)	Q_{gd}	—	6.6	—		
Turn-On Delay Time (Note 13)	$t_{D(ON)}$	—	8.1	—	ns	V_{DD} = 20V, V_{GS} = 10V I_D = 3A
Turn-On Rise Time (Note 13)	t_R	—	15.1	—		
Turn-Off Delay Time (Note 13)	$t_{D(OFF)}$	—	24.3	—		
Turn-Off Fall Time (Note 13)	t_F	—	5.3	—		

Electrical Characteristics (Q2 P-Channel) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	-40	—	—	V	I_D = -250µA, V_{GS} = 0V
Zero Gate Voltage Drain Current	I_{DSS}	—	—	-1.0	µA	V_{DS} = -40V, V_{GS} = 0V
Gate-Source Leakage	I_{GSS}	—	—	±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	-0.8	-1.3	-1.8	V	I_D = -250µA, V_{DS} = V_{GS}
Static Drain-Source On-Resistance (Note 11)	$R_{DS(ON)}$	—	0.018	0.025	Ω	V_{GS} = -10V, I_D = -3A
			0.030	0.045		V_{GS} = -4.5V, I_D = -3A
Forward Transconductance (Notes 11 & 12)	G_{fs}	—	16.6	—	S	V_{DS} = -5V, I_D = -3A
Diode Forward Voltage (Note 11)	V_{SD}	—	-0.7	-1.0	V	I_S = -1A, V_{GS} = 0V
DYNAMIC CHARACTERISTICS (Note 12)						
Input Capacitance	C_{iss}	—	1,643	—	pF	V_{DS} = -20V, V_{GS} = 0V f = 1MHz
Output Capacitance	C_{oss}	—	179	—		
Reverse Transfer Capacitance	C_{rss}	—	128	—		
Gate Resistance	R_g	—	6.43	—	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz
Total Gate Charge (Note 13)	Q_g	—	14.0	—	nC	V_{GS} = -4.5V; V_{DS} = -20V, I_D = -3A
Total Gate Charge (Note 13)	Q_g	—	33.7	—		V_{GS} = -10V; V_{DS} = -20V, I_D = -3A
Gate-Source Charge (Note 13)	Q_{gs}	—	5.5	—		
Gate-Drain Charge (Note 13)	Q_{gd}	—	7.3	—		
Turn-On Delay Time (Note 13)	$t_{D(ON)}$	—	6.9	—	ns	V_{DD} = -20V, V_{GS} = -10V I_D = -3A
Turn-On Rise Time (Note 13)	t_R	—	14.7	—		
Turn-Off Delay Time (Note 13)	$t_{D(OFF)}$	—	53.7	—		
Turn-Off Fall Time (Note 13)	t_F	—	30.9	—		

Notes: 11. Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%.
12. For design aid only, not subject to production testing.
13. Switching characteristics are independent of operating junction temperatures.

Typical Characteristics (Q1 N-Channel)

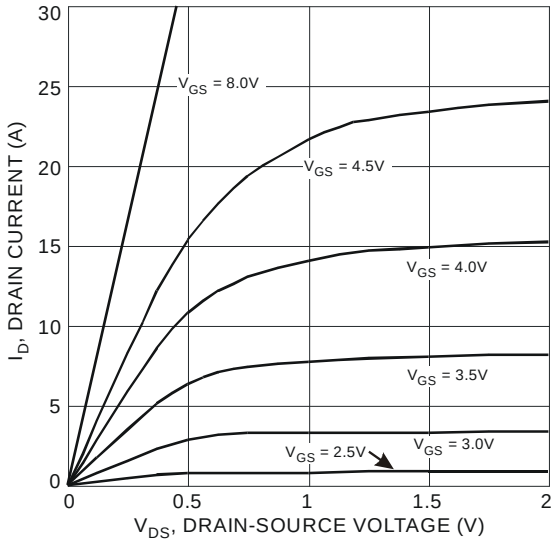


Fig. 1 Typical Output Characteristic

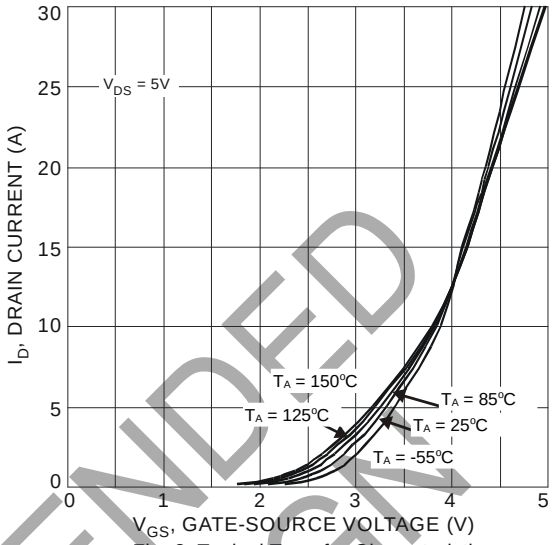


Fig. 2 Typical Transfer Characteristic

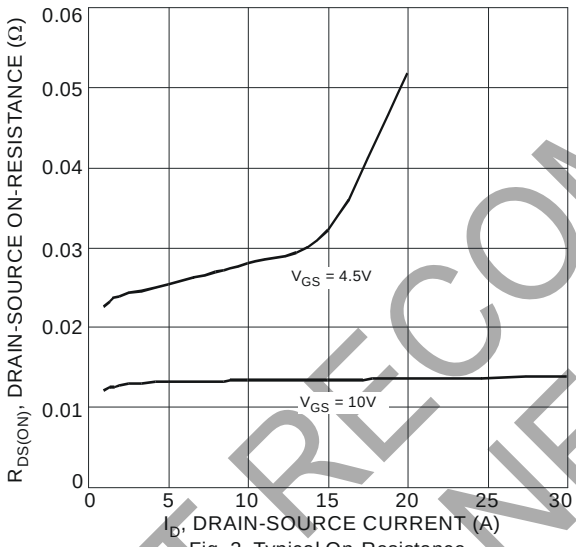


Fig. 3 Typical On-Resistance
vs. Drain Current and Gate Voltage

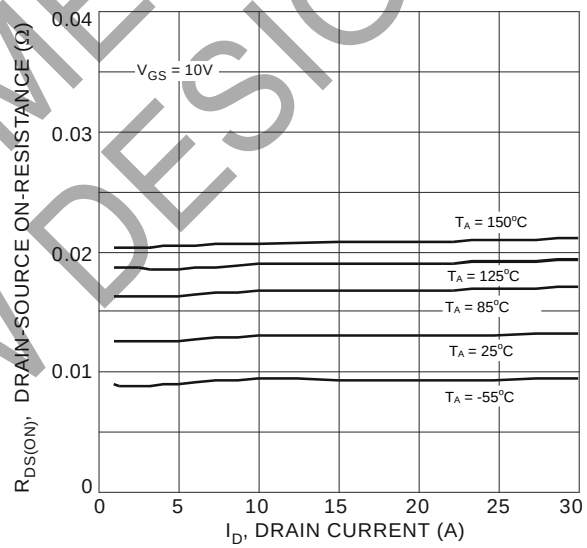


Fig. 4 Typical On-Resistance
vs. Drain Current and Temperature

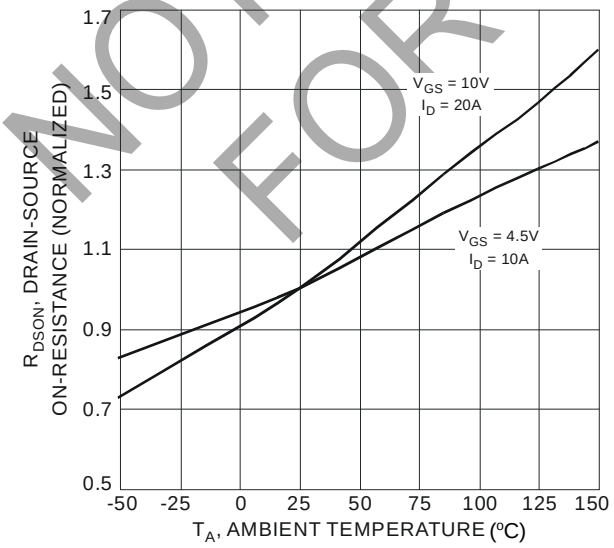


Fig. 5 On-Resistance Variation with Temperature

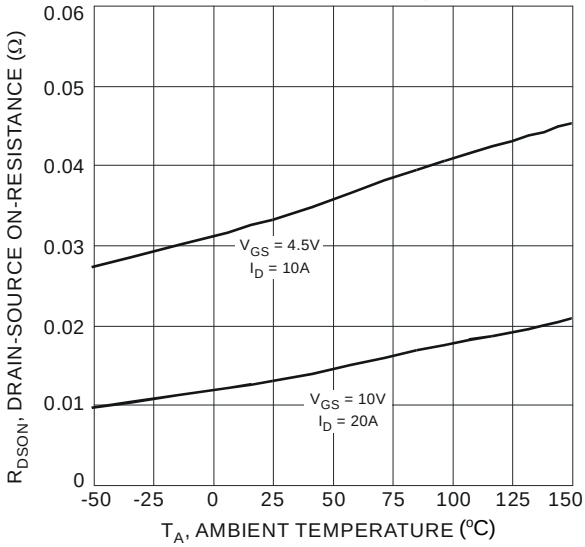


Fig. 6 On-Resistance Variation with Temperature

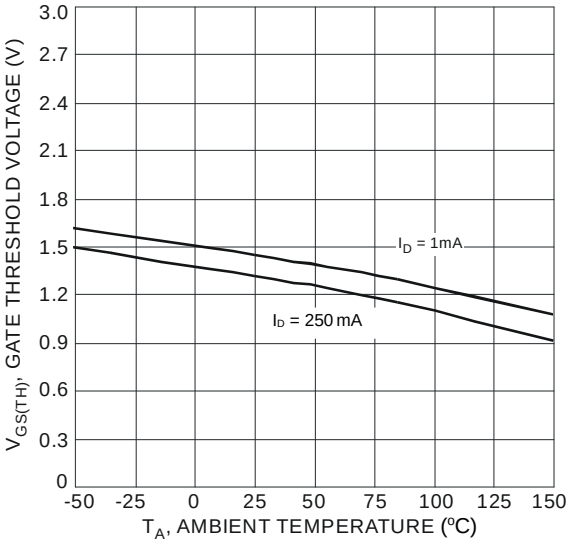


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

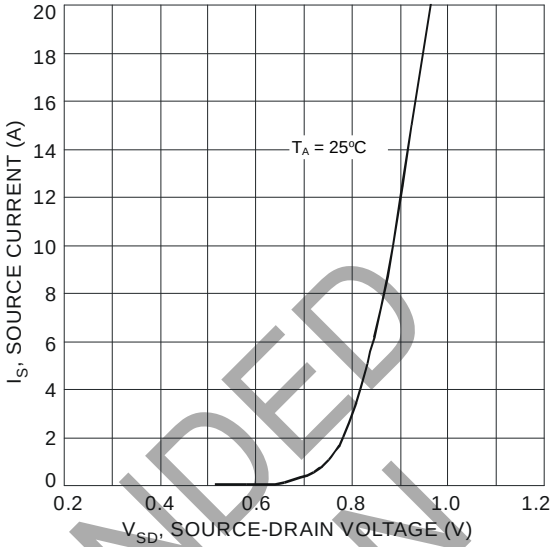


Fig. 8 Diode Forward Voltage vs. Current

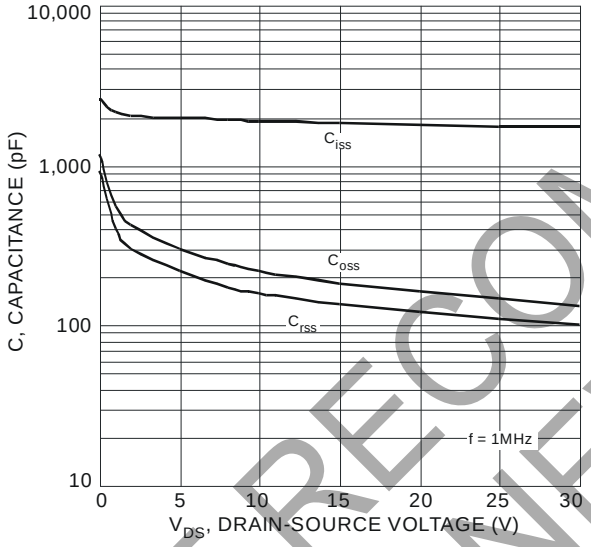


Fig. 9 Typical Total Capacitance

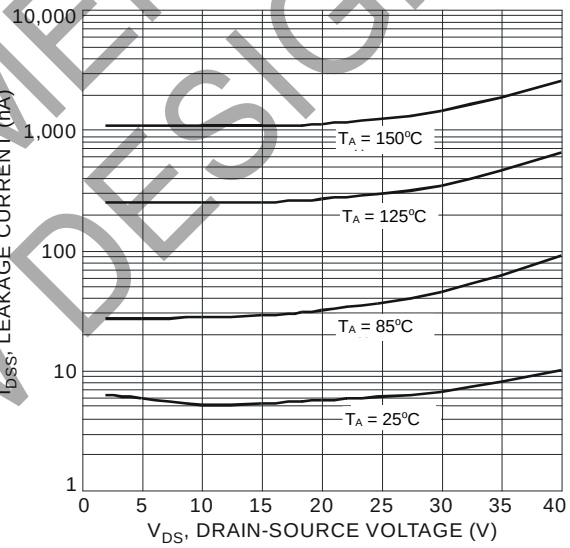


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage

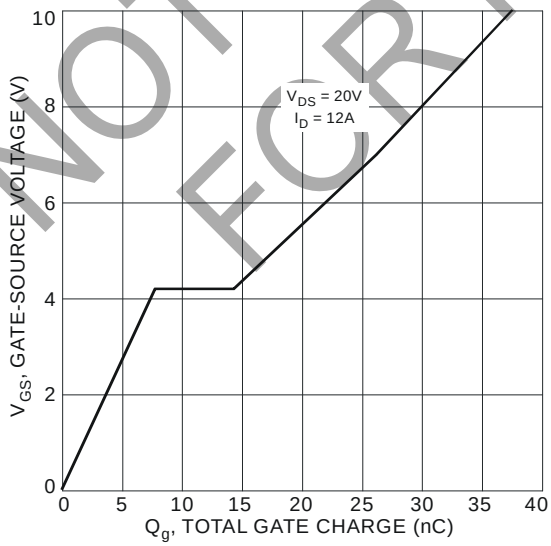


Fig. 11 Gate-Charge Characteristics

Typical Characteristics (Q2 P-Channel)

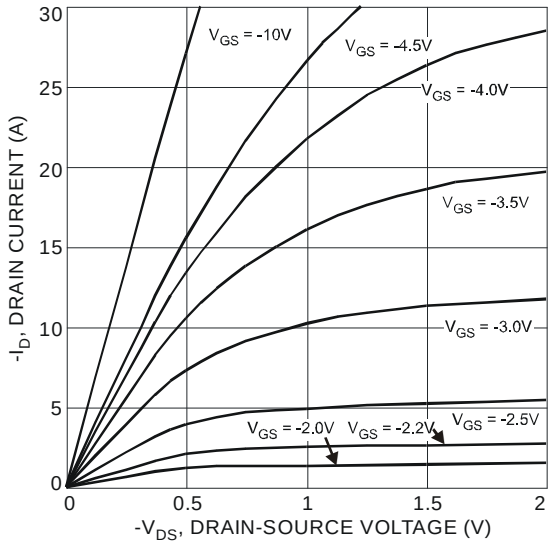


Fig. 12 Typical Output Characteristic

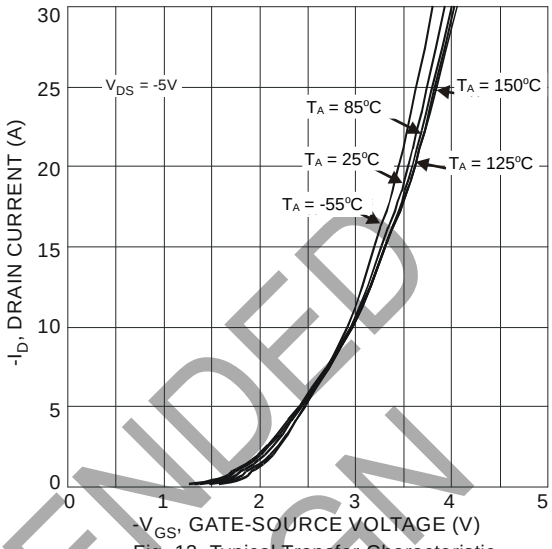


Fig. 13 Typical Transfer Characteristic

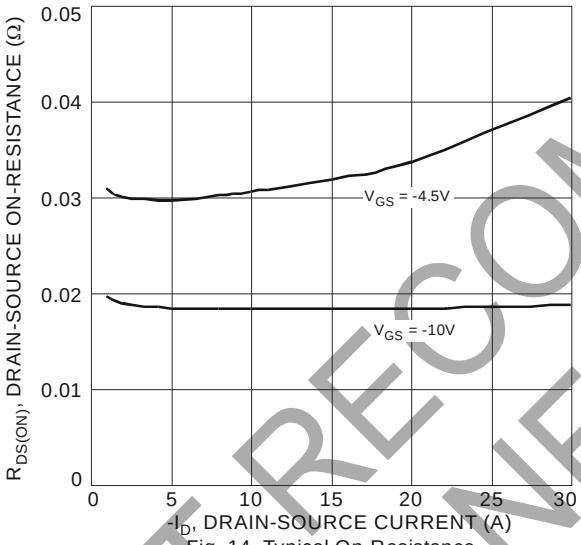


Fig. 14 Typical On-Resistance
vs. Drain Current and Gate Voltage

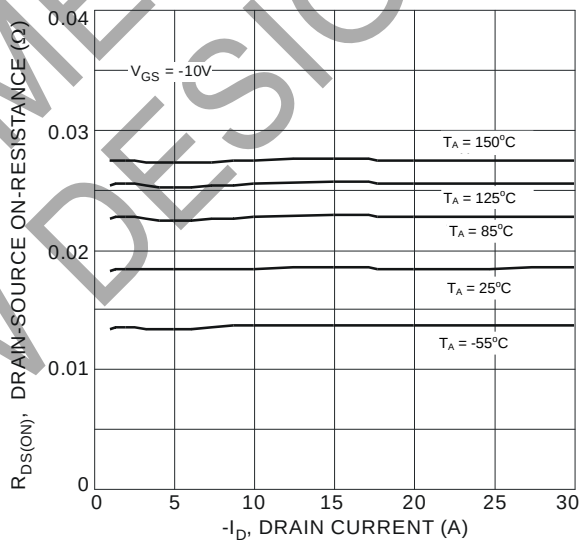


Fig. 15 Typical On-Resistance
vs. Drain Current and Temperature

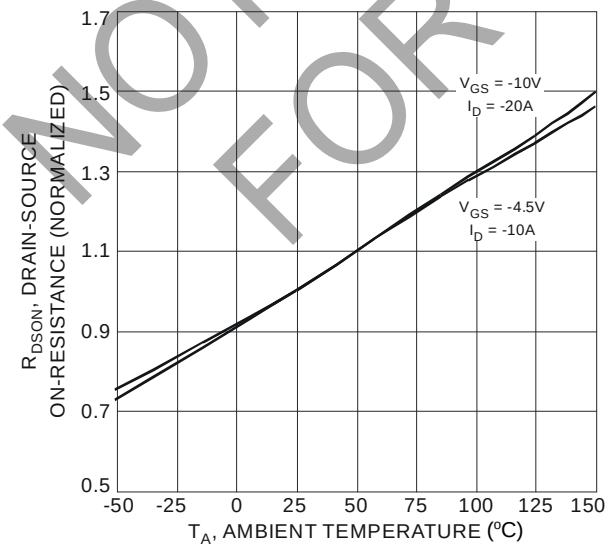


Fig. 16 On-Resistance Variation with Temperature

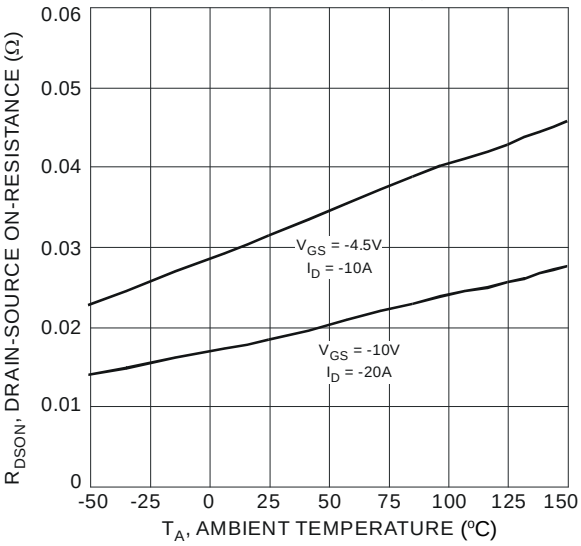


Fig. 17 On-Resistance Variation with Temperature

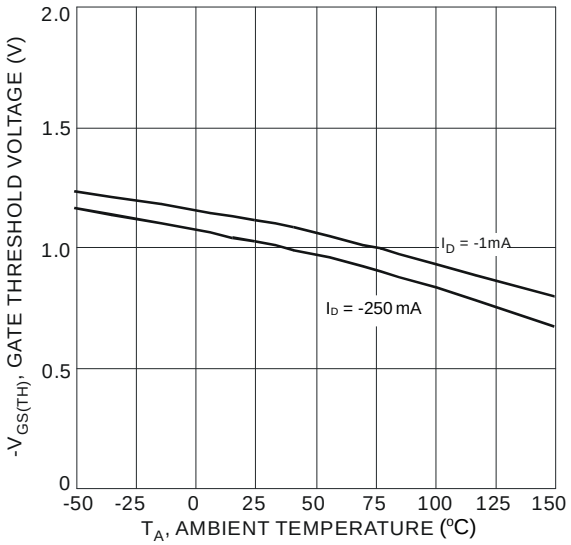


Fig. 18 Gate Threshold Variation vs. Ambient Temperature

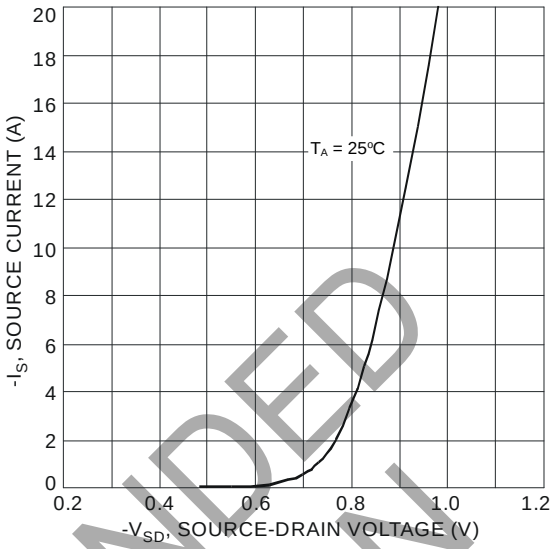


Fig. 19 Diode Forward Voltage vs. Current

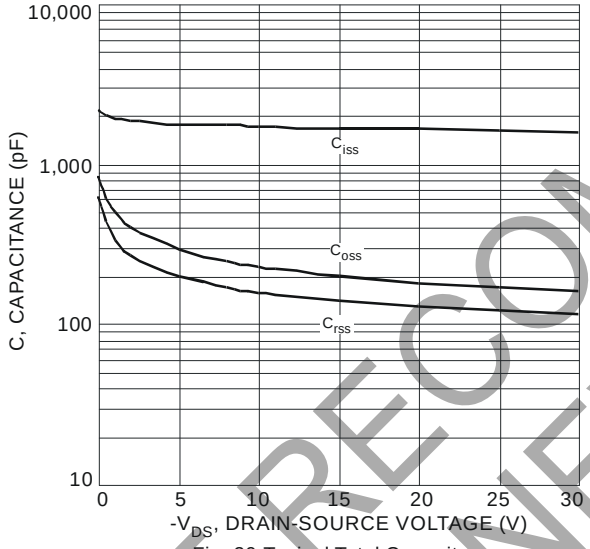


Fig. 20 Typical Total Capacitance

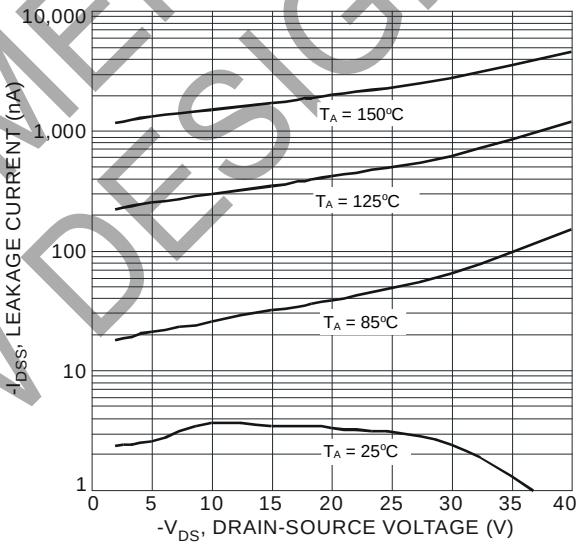


Fig. 21 Typical Leakage Current
vs. Drain-Source Voltage

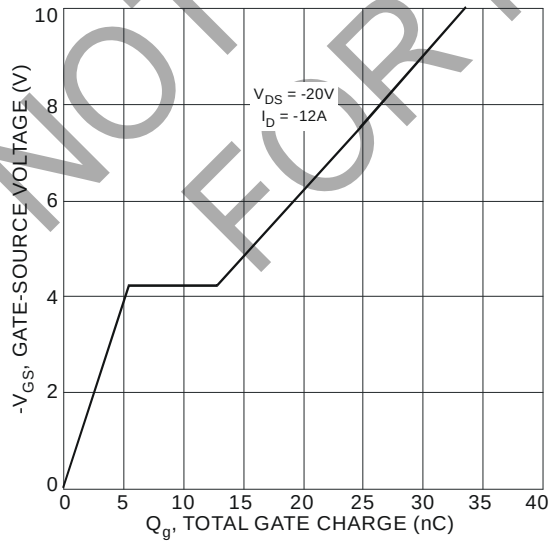
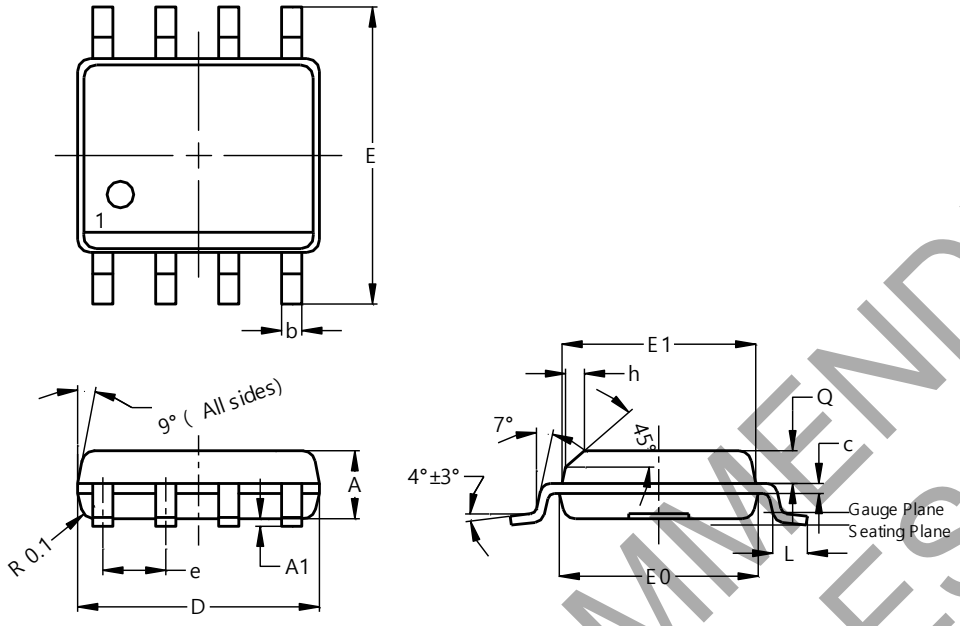


Fig. 22 Gate-Charge Characteristics

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8

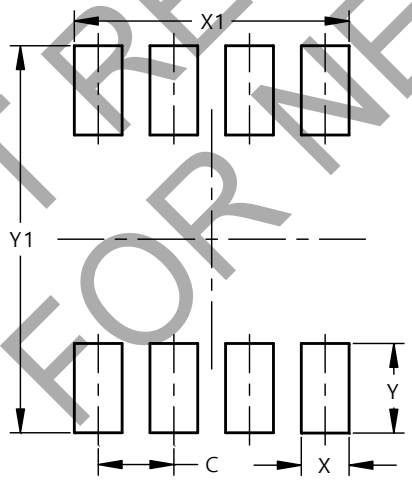


SO-8			
Dim	**Min**	**Max**	**Typ**
A	1.40	1.50	1.45
A1	0.10	0.20	0.15
b	0.30	0.50	0.40
c	0.15	0.25	0.20
D	4.85	4.95	4.90
E	5.90	6.10	6.00
E1	3.80	3.90	3.85
E0	3.85	3.95	3.90
e	--	--	1.27
h	-	--	0.35
L	0.62	0.82	0.72
Q	0.60	0.70	0.65
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Dimensions	Value (in mm)
C	1.27
X	0.802
X1	4.612
Y	1.505
Y1	6.50

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